

L Number	Hits	Search Text	DB	Time stamp
1	463	204/273.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 13:45
2	26	204/273.ccls. AND wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 13:48
5	10	204/273.ccls. AND stir\$4 AND wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 13:49
3	69	204/273.ccls. AND stir\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 14:38
6	4	US-0628058-\$.DID. OR US-0628058-\$.DID. OR US-0625125-\$.DID. OR US-6099712-\$.DID.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 13:57
7	2	US-0628058-\$.DID. OR US-0628058-\$.DID. OR US-0625125-\$.DID. OR US-6099712-\$.DID. AND stir\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 13:57
8	61	205/148.ccls. and stir\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 15:46
9	18	204/261.ccls. and stir\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 15:54
10	0	204/\$ccls. and stir\$4 AND wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/22 15:55